

2N4453

For Specifications, See 2N869A Data.

2N4890**CASE 79-02, STYLE 1
TO-39 (TO-205AD)****GENERAL PURPOSE
TRANSISTOR****PNP SILICON****4****MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CEO}	40	Vdc
Collector-Base Voltage	V_{CBO}	60	Vdc
Emitter-Base Voltage	V_{EBO}	5.0	Vdc
Collector Current — Continuous	I_C	1.0	Adc
Total Device Dissipation ($\alpha T_A = 25^\circ\text{C}$ Derate above 25°C)	P_D	1.0 5.7	Watt $\text{mW}/^\circ\text{C}$
Total Device Dissipation ($\alpha T_C = 25^\circ\text{C}$ Derate above 25°C)	P_D	5.0 28.6	Watts $\text{mW}/^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-65 to +200	$^\circ\text{C}$

Refer to 2N4033 for graphs.

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage(1) ($I_C = 100 \mu\text{Adc}, I_B = 0$)	$V_{(BR)CEO}$	40	—	—	Vdc
Collector-Emitter Breakdown Voltage ($I_C = 10 \text{ mAdc}, R_{BE} = 10 \text{ ohms}$)	$V_{(BR)CER}$	50	—	—	Vdc
Collector-Base Breakdown Voltage ($I_C = 100 \mu\text{Adc}, I_E = 0$)	$V_{(BR)CBO}$	60	—	—	Vdc
Emitter-Base Breakdown Voltage ($I_E = 100 \mu\text{Adc}, I_C = 0$)	$V_{(BR)EBO}$	5.0	—	—	Vdc
Collector Cutoff Current ($V_{CE} = 60 \text{ Vdc}, V_{BE(\text{off})} = 1.5 \text{ Vdc}$)	I_{CEX}	—	—	0.25	μAdc
Base Cutoff Current ($V_{CE} = 60 \text{ Vdc}, V_{BE(\text{off})} = 1.5 \text{ Vdc}$)	I_{BL}	—	—	0.25	μAdc

ON CHARACTERISTICS

DC Current Gain ($I_C = 150 \text{ mAdc}, V_{CE} = 2.5 \text{ Vdc}$) ($I_C = 150 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$) *($I_C = 500 \text{ mA}, V_{CE} = 5 \text{ Vdc}(1)$)	h_{FE}	25 50 15	130 140 —	— 250 —	—
Collector-Emitter Saturation Voltage ($I_C = 150 \text{ mAdc}, I_B = 15 \text{ mAdc}$)	$V_{CE(\text{sat})}$	—	0.12	1.4	Vdc
Base-Emitter Saturation Voltage ($I_C = 150 \text{ mAdc}, I_B = 15 \text{ mAdc}$)	$V_{BE(\text{sat})}$	—	0.82	1.7	Vdc
Base-Emitter On Voltage ($I_C = 150 \text{ mAdc}, V_{CE} = 2.5 \text{ Vdc}$)	$V_{BE(\text{on})}$	—	0.74	1.7	Vdc

SMALL-SIGNAL CHARACTERISTICS

Current-Gain — Bandwidth Product ($I_C = 50 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 20 \text{ MHz}$)	f_T	100	280	—	MHz
Output Capacitance ($V_{CB} = 10 \text{ Vdc}, I_E = 0, f = 140 \text{ kHz}$)	C_{obo}	—	9.0	15	pF
Input Capacitance ($V_{BE} = 0.5 \text{ Vdc}, I_C = 0, f = 140 \text{ kHz}$)	C_{ibo}	—	60	80	pF

SWITCHING CHARACTERISTICS

Delay Time	$(V_{CC} = 30 \text{ Vdc}, V_{BE(\text{off})} = 0.8 \text{ Vdc}, I_C = 150 \text{ mAdc}, I_{B1} = 15 \text{ mAdc})$	t_d	—	15	50	ns
Rise Time		t_r	20	20	50	ns
Storage Time	$(V_{CC} = 30 \text{ Vdc}, I_C = 150 \text{ mAdc}, I_{B1} = I_{B2} = 15 \text{ mAdc})$	t_s	—	110	200	ns
Fall Time		t_f	—	20	70	ns

(1) Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.

*Indicates Data in Addition to JEDEC Requirements.